

## N-Channel Enhancement Mode Power MOSFET

### Description

The K15N10G uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other switching application.

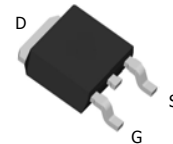
### General Features

- High power and current handling capability
- Lead free product is acquired
- Surface mount package

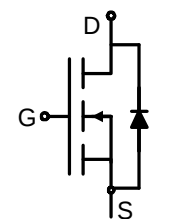
### Application

- Battery switch
- DC/DC converter

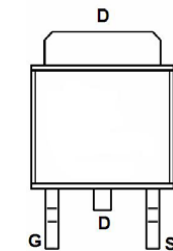
### TO-252



### Equivalent Circuit



### MARKING



### Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ unless otherwise noted)

| Parameter                                         | Symbol         | Limit      | Unit             |
|---------------------------------------------------|----------------|------------|------------------|
| Drain-Source Voltage                              | $V_{DS}$       | 100        | V                |
| Gate-Source Voltage                               | $V_{GS}$       | $\pm 20$   | V                |
| Drain Current-Continuous $T_C=25^\circ\text{C}$   | $I_D$          | 12         | A                |
| Drain Current-Continuous $T_C=100^\circ\text{C}$  |                | 8.4        | A                |
| Drain Current-Pulsed <sup>(Note 1)</sup>          | $I_{DM}$       | 30         | A                |
| Maximum Power Dissipation $T_C=25^\circ\text{C}$  | $P_D$          | 30         | W                |
| Maximum Power Dissipation $T_C=100^\circ\text{C}$ |                | 15         | W                |
| Operating Junction and Storage Temperature Range  | $T_J, T_{STG}$ | -55 To 175 | $^\circ\text{C}$ |

### Thermal Characteristic

|                                                          |                 |   |                    |
|----------------------------------------------------------|-----------------|---|--------------------|
| Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup> | $R_{\theta JC}$ | 5 | $^\circ\text{C/W}$ |
|----------------------------------------------------------|-----------------|---|--------------------|

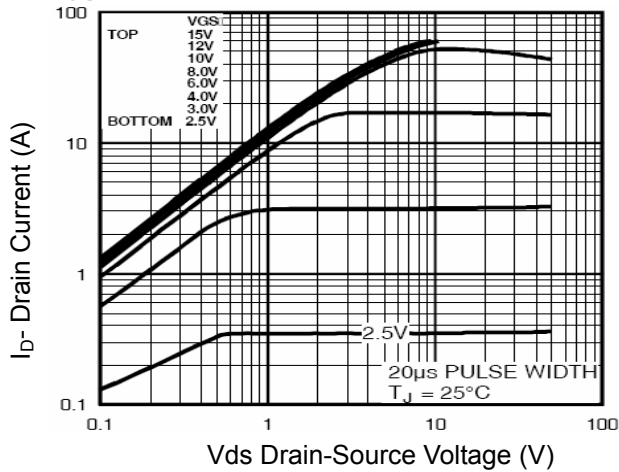
### Electrical Characteristics (T<sub>C</sub>=25°C unless otherwise noted)

| Parameter                                     | Symbol              | Condition                                                                             | Min | Typ   | Max   | Unit |
|-----------------------------------------------|---------------------|---------------------------------------------------------------------------------------|-----|-------|-------|------|
| Off Characteristics                           |                     |                                                                                       |     |       |       |      |
| Drain-Source Breakdown Voltage                | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V I <sub>D</sub> =250μA                                             | 100 | 107   | -     | V    |
| Zero Gate Voltage Drain Current               | I <sub>DSS</sub>    | V <sub>DS</sub> =100V, V <sub>GS</sub> =0V                                            | -   | -     | 1     | μA   |
| Gate-Body Leakage Current                     | I <sub>GSS</sub>    | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V                                            | -   | -     | ±100  | nA   |
| On Characteristics <sup>(Note 3)</sup>        |                     |                                                                                       |     |       |       |      |
| Gate Threshold Voltage                        | V <sub>GS(th)</sub> | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA                              | 1.2 | 1.8   | 2.5   | V    |
| Drain-Source On-State Resistance              | R <sub>DS(ON)</sub> | V <sub>GS</sub> =10V, I <sub>D</sub> =6A                                              | -   | 0.120 | 0.136 | Ω    |
| Drain-Source On-State Resistance              | R <sub>DS(ON)</sub> | V <sub>GS</sub> =4.5V, I <sub>D</sub> =6A                                             | -   | 0.130 | 0.146 | Ω    |
| Forward Transconductance                      | g <sub>FS</sub>     | V <sub>DS</sub> =25V, I <sub>D</sub> =6A                                              | 3.5 | -     | -     | S    |
| Dynamic Characteristics <sup>(Note4)</sup>    |                     |                                                                                       |     |       |       |      |
| Input Capacitance                             | C <sub>iss</sub>    | V <sub>DS</sub> =25V, V <sub>GS</sub> =0V,<br>F=1.0MHz                                | -   | 206   | -     | PF   |
| Output Capacitance                            | C <sub>oss</sub>    |                                                                                       | -   | 28.6  | -     | PF   |
| Reverse Transfer Capacitance                  | C <sub>rss</sub>    |                                                                                       | -   | 1.6   | -     | PF   |
| Switching Characteristics <sup>(Note 4)</sup> |                     |                                                                                       |     |       |       |      |
| Turn-on Delay Time                            | t <sub>d(on)</sub>  | V <sub>DD</sub> =50V, I <sub>D</sub> =5A,<br>V <sub>GS</sub> =10V, R <sub>G</sub> =2Ω | -   | 14.7  | -     | nS   |
| Turn-on Rise Time                             | t <sub>r</sub>      |                                                                                       | -   | 3.5   | -     | nS   |
| Turn-Off Delay Time                           | t <sub>d(off)</sub> |                                                                                       | -   | 20.9  | -     | nS   |
| Turn-Off Fall Time                            | t <sub>f</sub>      |                                                                                       | -   | 2.7   | -     | nS   |
| Total Gate Charge                             | Q <sub>g</sub>      | V <sub>DS</sub> =50V, I <sub>D</sub> =5A,<br>V <sub>GS</sub> =10V                     | -   | 4.3   | -     | nC   |
| Gate-Source Charge                            | Q <sub>gs</sub>     |                                                                                       | -   | 1.5   | -     | nC   |
| Gate-Drain Charge                             | Q <sub>gd</sub>     |                                                                                       | -   | 1.1   | -     | nC   |
| Drain-Source Diode Characteristics            |                     |                                                                                       |     |       |       |      |
| Diode Forward Voltage <sup>(Note 3)</sup>     | V <sub>SD</sub>     | V <sub>GS</sub> =0V, I <sub>S</sub> =9.6A                                             | -   | -     | 1.2   | V    |
| Diode Forward Current <sup>(Note 2)</sup>     | I <sub>S</sub>      |                                                                                       | -   | -     | 12    | A    |
| Reverse Recovery Time                         | t <sub>rr</sub>     | TJ = 25°C, IF =5.6A                                                                   | -   | 21    |       | nS   |
| Reverse Recovery Charge                       | Q <sub>rr</sub>     | di/dt = 100A/μs <sup>(Note3)</sup>                                                    | -   | 97    |       | nC   |
| Forward Turn-On Time                          | t <sub>on</sub>     | Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)                  |     |       |       |      |

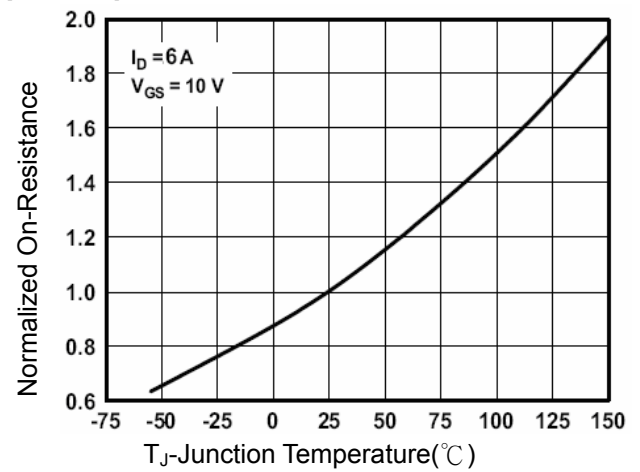
### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production

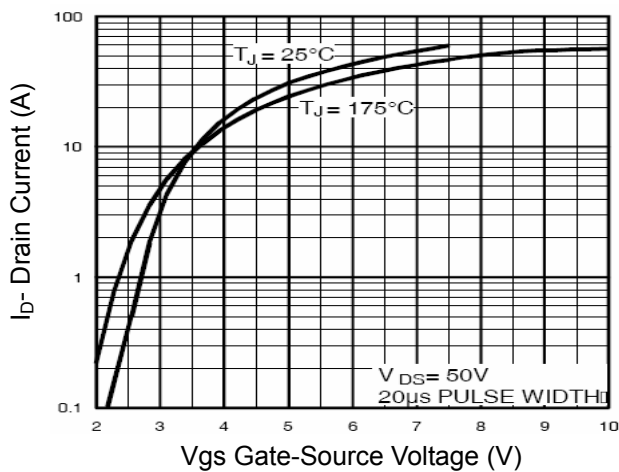
**Typical Electrical and Thermal Characteristics (Curves)**



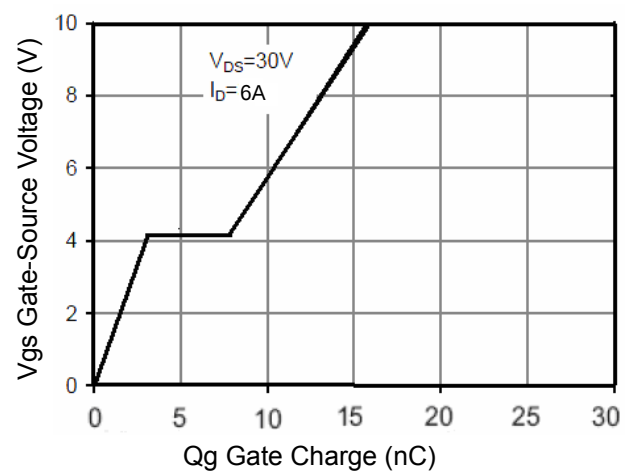
**Figure 1 Output Characteristics**



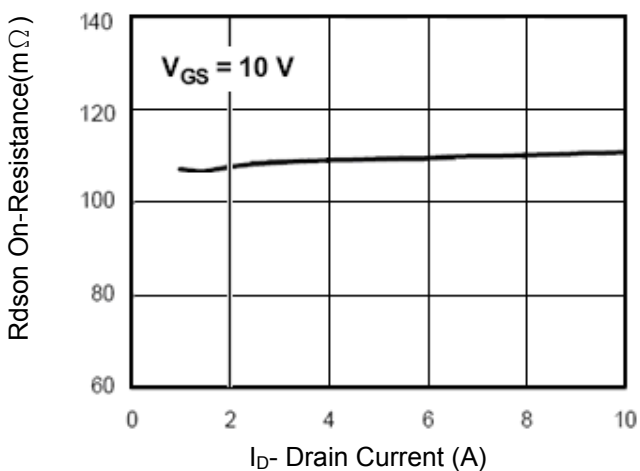
**Figure 4 Rdson-Junction Temperature**



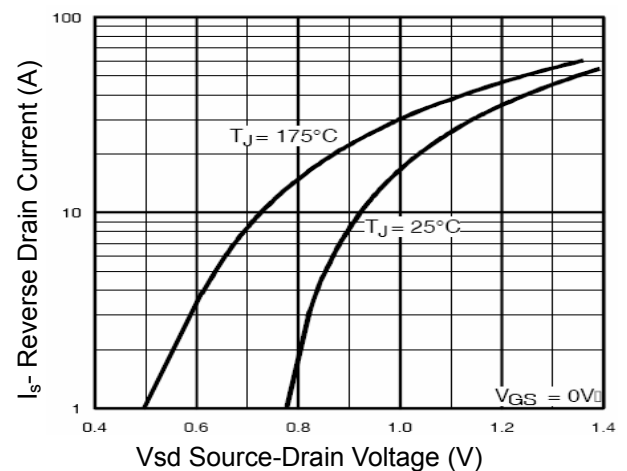
**Figure 2 Transfer Characteristics**



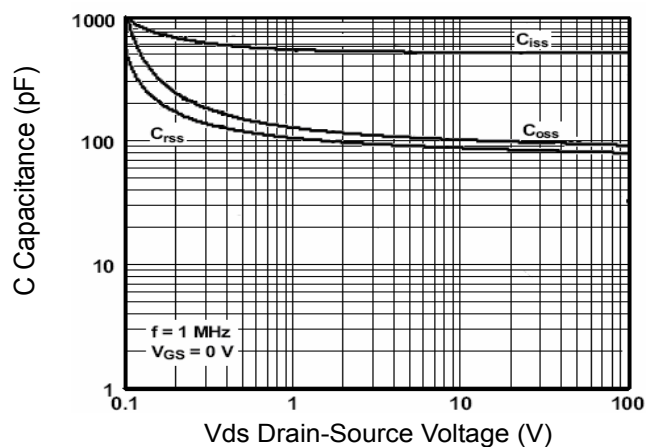
**Figure 5 Gate Charge**



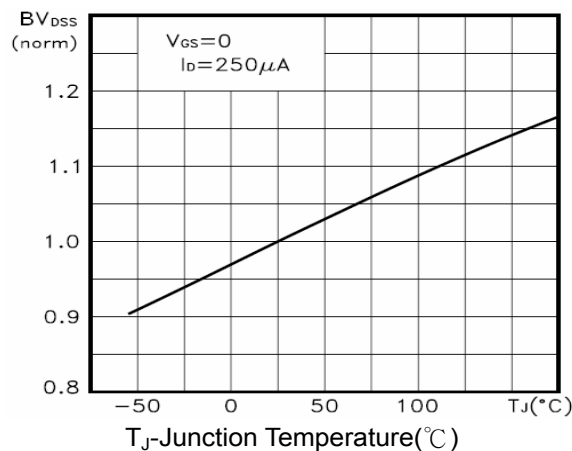
**Figure 3 Rdson- Drain Current**



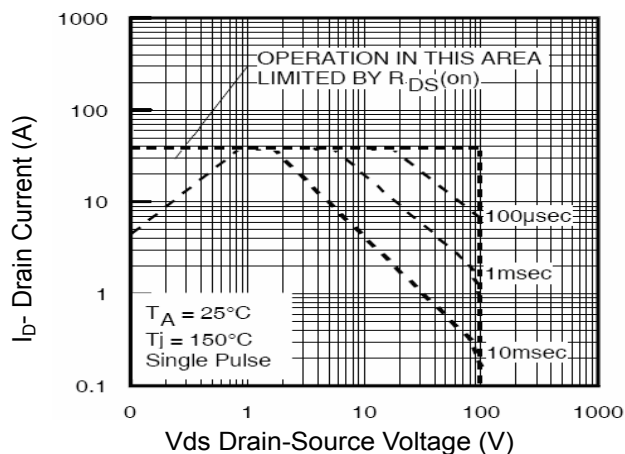
**Figure 6 Source- Drain Diode Forward**



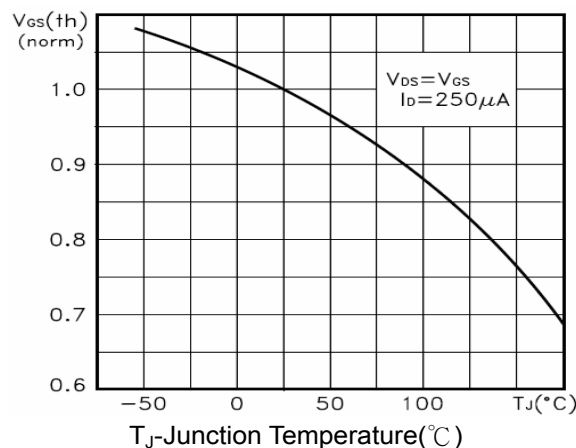
**Figure 7 Capacitance vs Vds**



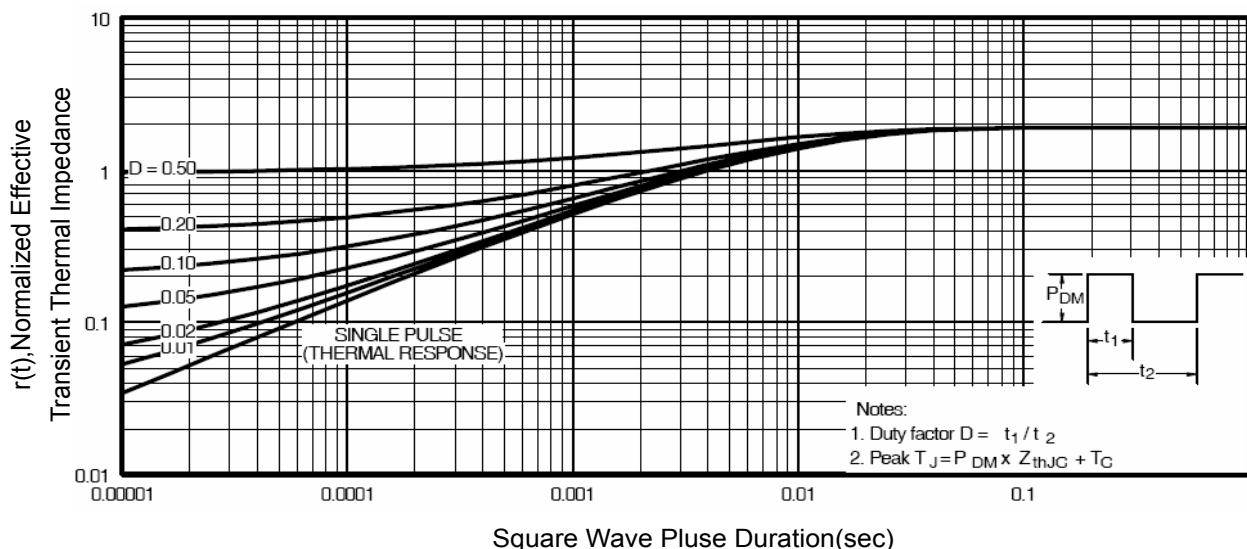
**Figure 9  $BV_{DSS}$  vs Junction Temperature**



**Figure 8 Safe Operation Area**



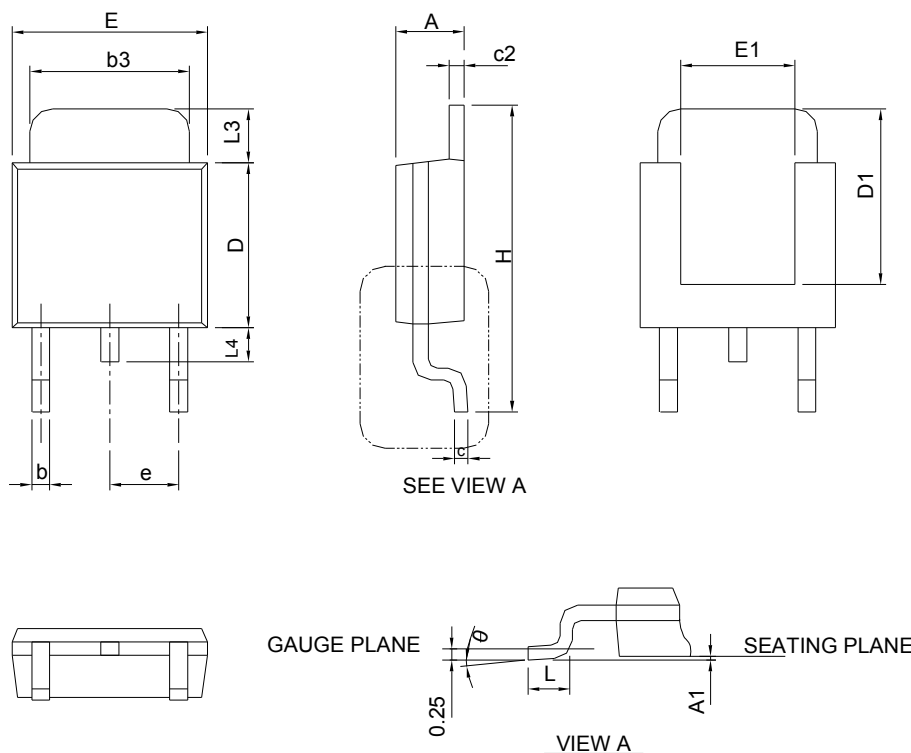
**Figure 10  $V_{GS(th)}$  vs Junction Temperature**



**Figure 11 Normalized Maximum Transient Thermal Impedance**

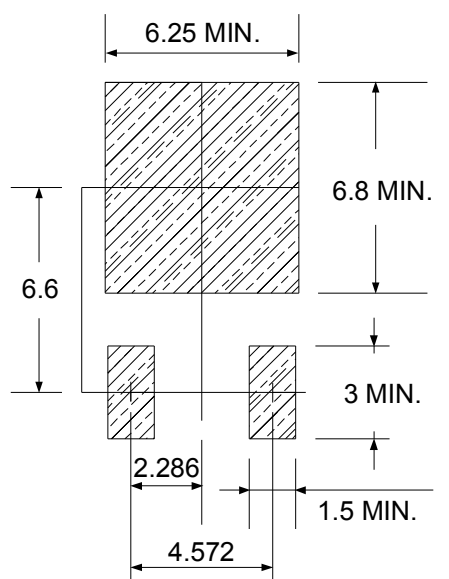
## Package Information

### TO-252



| DIMENSIONS | TO-252-3    |       |           |       |
|------------|-------------|-------|-----------|-------|
|            | MILLIMETERS |       | INCHES    |       |
|            | MIN.        | MAX.  | MIN.      | MAX.  |
| A          | 2.18        | 2.39  | 0.086     | 0.094 |
| A1         |             | 0.13  |           | 0.005 |
| b          | 0.50        | 0.89  | 0.020     | 0.035 |
| b3         | 4.95        | 5.46  | 0.195     | 0.215 |
| c          | 0.46        | 0.61  | 0.018     | 0.024 |
| c2         | 0.46        | 0.89  | 0.018     | 0.035 |
| D          | 5.33        | 6.22  | 0.210     | 0.245 |
| D1         | 4.57        | 6.00  | 0.180     | 0.236 |
| E          | 6.35        | 6.73  | 0.250     | 0.265 |
| E1         | 3.81        | 6.00  | 0.150     | 0.236 |
| e          | 2.29 BSC    |       | 0.090 BSC |       |
| H          | 9.40        | 10.41 | 0.370     | 0.410 |
| L          | 0.90        | 1.78  | 0.035     | 0.070 |
| L3         | 0.89        | 2.03  | 0.035     | 0.080 |
| L4         |             | 1.02  |           | 0.040 |
| θ          | 0°          | 8°    | 0°        | 8°    |

### RECOMMENDED LAND PATTERN



UNIT: mm